

# CGB3B1X6S0G475K055AC

TDK Item Description : CGB3B1X6S0G475KT\*\*\*\*

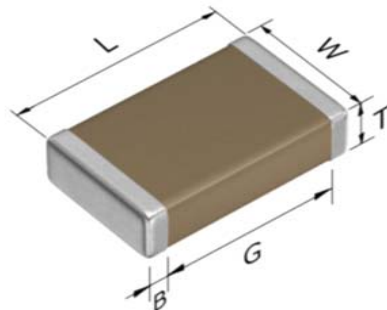


## Application & Main Feature

Commercial Grade ( Low Profile )

## Series

CGB3(1608) [EIA CC0603]



## Dimensions

L 1.60mm +/-0.1mm  
 W 0.80mm +/-0.1mm  
 T 0.50mm +/-0.05mm  
 B 0.20mm Min.  
 G 0.30mm Min.

## Temperature Characteristic

X6S (-55 to 105 degC +/-22%)

## Rated Voltage

0G (4Vdc)

## Capacitance

4.7uF

## Capacitance Tolerance

K (+/-10%)

## Dissipation Factor

10% Max.

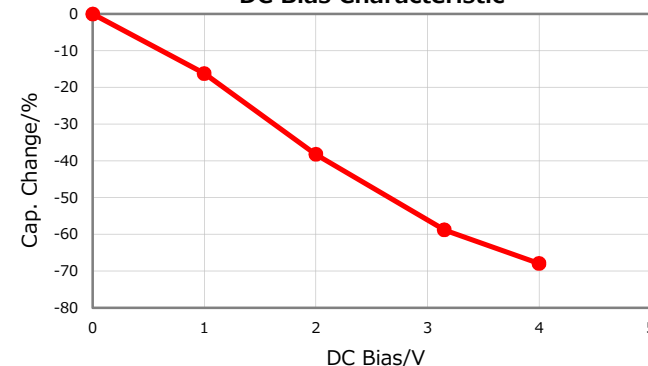
## Insulation Resistance

21Mohm Min.

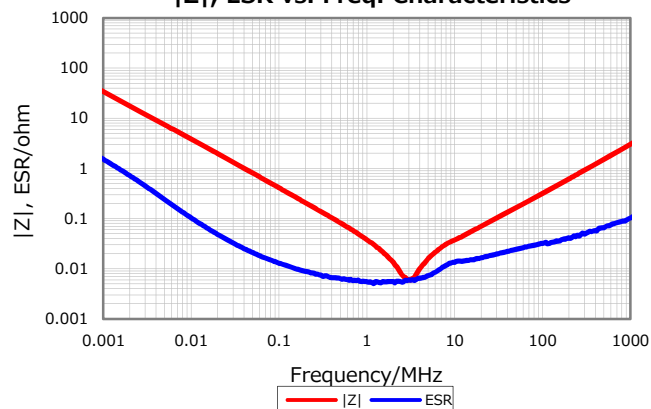
## AEC-Q200

Not Applicable

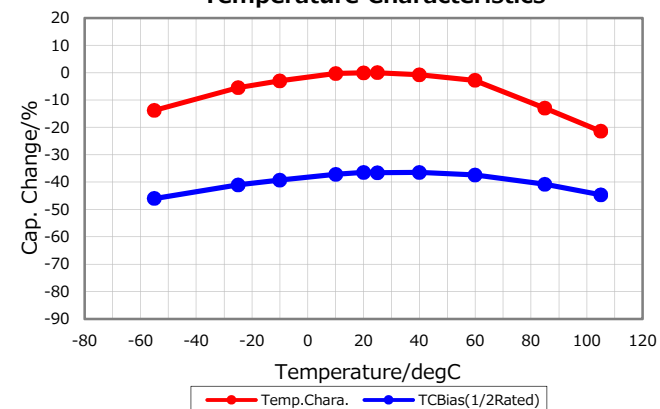
## DC Bias Characteristic



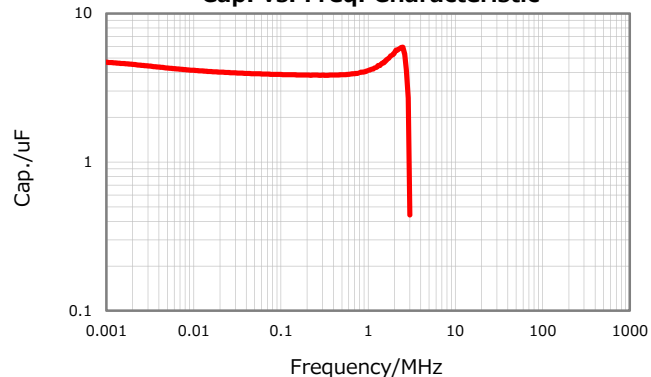
## |Z|, ESR vs. Freq. Characteristics



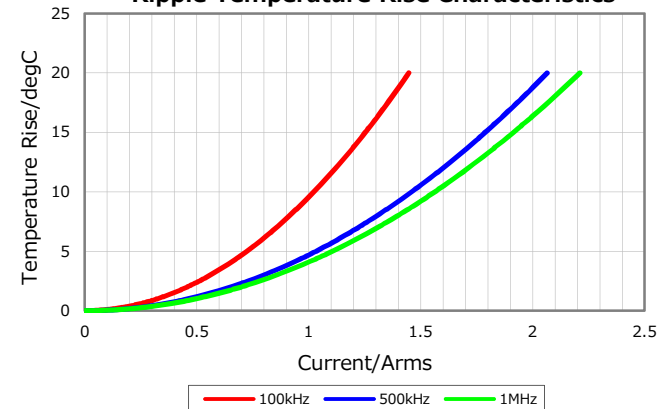
## Temperature Characteristics



## Cap. vs. Freq. Characteristic



## Ripple Temperature Rise Characteristics



Characterization Sheet ( Multilayer Ceramic Chip Capacitors )



All specifications are subject to change without notice.

November 27, 2018